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# HTU31 RH/T SENSOR IC

Relative Humidity & Temperature Sensor

- HTU31D Digital RH/T Sensor
- HTU31V Analog RH/T Sensor

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#### **Features**

- High Reliability and Robustness
- Fast Recovery after Saturation
- Fully Compatible with Reflow Process
- Fully Interchangeable without Calibration
- Serial Individual Marking for Traceability
- Lead Free
- Low Power Consumption

#### **Applications**

- Home Appliance
- HVAC
- Medical Respirators CPAP and Ventilators
- Industrial Transport / Cold Chain
- Humidifiers / Dehumidifier
- Meteorology
- Environmental Monitoring & Trackers
- IoT Applications
- IP Camera
- Water Leak Detector

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# HTU31D RH/T SENSOR IC

Digital Relative Humidity & Temperature Sensor

#### Characteristics

- Fully calibrated, temperature compensated digital output
- High accuracy: ±2%RH and ±0.2°C
- Fast humidity response time: 3s
- Long term drift: <0.1%RH/year
- Wide supply voltage range from 3V to 5.5V
- Low average current: 1µA typical
- Compact 6-Pin DFN package: 2.5x2.5x0.9mm
- Fast I2C Interface with 2 configurable addresses
- Fully RoHS and REACH compliant

## **General Description**

The HTU31 is one of the smallest and most accurate humidity sensors on the market. TE Connectivity precision engineering and 20+ years of experience in humidity and temperature combination sensors, enabled this new product with fast response time, precision measurement, low hysteresis, robustness to reflow assembly process and sustained performance even when exposed to extreme temperature [-40° to 125°C] and humidity [0%RH to 100%RH] environments.

HTU31 humidity & temperature sensor includes both digital (D) and analog (V) versions and combines multiple functions with an application-friendly operating supply voltage range from 3V to 5.5V.

HTU31 sensor is available in small and large volumes to meet the everchanging demands of our customers.

# PERFORMANCE SPECIFICATIONS

# Relative Humidity Specifications

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Condition	Value	Units	Notes / Conditions
Humidity Operating Range	Max <sup>1</sup>	0 to 100	%RH	
Relative Humidity Accuracy	Typical	±2	%RH	Figure 1 Humidity Sensor Rating @25°C
Resolution	Typical	0.01	%RH	Table 11 Humidity and Temperature Conversion Parameters
Hysteresis	@25°C	±0.7	%RH	
Response Time <sup>2</sup>	τ63%	3	S	
Recovery Time after Condensation <sup>3</sup>	τ100%	10	S	
Long Term Drift <sup>4</sup>	Typical	<0.1	%RH / year	

Table 1 Humidity Specifications

# **Temperature Specifications**

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Condition	Value	Units	Notes / Conditions
Temperature Operating Range		-40 to 125	°C	
Temperature Accuracy	Typical	±0.2	°C	Figure 2 Temperature Sensor Rating
Resolution	Typical	0.016	°C	Table 11 Humidity and Temperature Conversion Parameters
Response Time <sup>2</sup>	τ63%	10	S	
Long Term Drift	Typical	0.04	°C / year	

Table 2 Temperature Specifications

 $<sup>^{\</sup>rm 1}$  Cf. Figure 3 Humidity and Temperature Operating Range  $^{\rm 2}$  With 1m.s  $^{\rm 1}$  air flow

<sup>&</sup>lt;sup>3</sup> Measured according to AFNOR standard NFX 15-113, with 3 m.s<sup>-1</sup> air flow

<sup>&</sup>lt;sup>4</sup> Typical application in regular environmental variation within optimum measurement range

# **Humidity Sensor Rating**

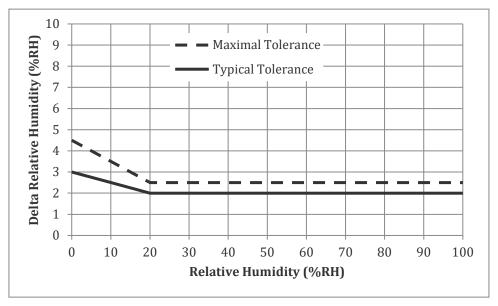


Figure 1 Humidity Sensor Rating @25°C

# **Temperature Sensor Rating**

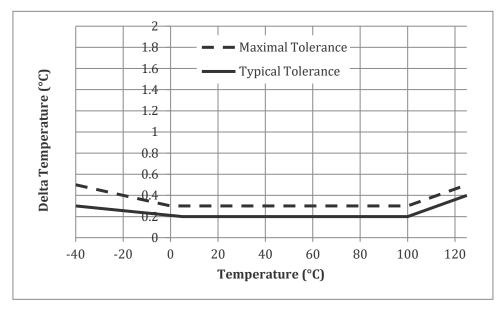


Figure 2 Temperature Sensor Rating

# SENSOR INTEGRATION

## **Absolute Maximum Operating Conditions**

Ratings	Symbol	Value	Unit	Notes / Conditions
Storage Temperature <sup>5</sup>	Tstg	-40 to 200	°C	
Supply Voltage (Peak)	Vcc	5.5	Vdc	
<b>Humidity Operating Range</b>	RH	0 to 100	%RH	
Temperature Operating Range	Та	-40 to +125	°C	
VDD to GND		-0.3 to 5.5	V	
Digital I/O pins (DATA/SCL) to GND		-0.3 to VDD +0.3	V	
ESD HBM (Human Body Model) <sup>6</sup>		±8	kV	
ESD CDM (Charged Device Model) <sup>7</sup>		750	V	
Latch Up Sensitivity <sup>8</sup>		±300	mA	

Table 3 Maximum Operating Conditions

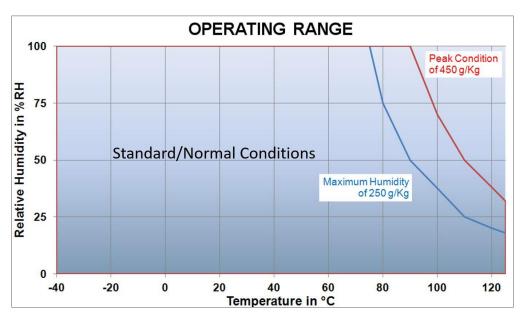


Figure 3 Humidity and Temperature Operating Range

The sensor should operate at peak condition less than 10% of the operating life. Exposure to absolute maximum humidity/temperature conditions for extended periods may temporarily induce an offset on RH measurement (+5%RH above accuracy specifications, which will recover over time) and accelerate its ageing.

 $<sup>^5</sup>$  Sensor in specifications after 1000h storage @125°C; No failure after 1000h storage @200°C  $^6$  According to ANSI/ESDA/JEDEC JS-001-2017, AEC-Q100-002.

<sup>&</sup>lt;sup>7</sup> According to JESD22-C101, AEC-Q100-011

<sup>&</sup>lt;sup>8</sup> According to JESD78

# **Electrical Specifications**

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Symbol	Min	Тур	Max	Unit	Notes / Conditions
Supply Voltage	$V_{dd}$	3.0	5.0	5.5	V	
	i <sub>dd</sub>		0.13	0.40	μΑ	Sleep mode
<b>Current Consumption</b>			1.04		μΑ	Typical <sup>9</sup>
			414		μΑ	Peak / Measuring mode
			0.65	2.00	μW	Sleep mode
Power Dissipation			5.20		μW	Typical <sup>9</sup>
			2.07		mW	Peak / Measuring mode
Heater	R <sub>heat</sub>	1.5	2.0	2.5	kΩ	$P_{heat} = \frac{V_{dd}^2}{R_{heat}}$
	P <sub>heat</sub>	10	12.5	16	mW	

Table 4 Electrical Specifications

# **Timing Specifications**

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Symbol	Min	Тур	Max	Unit	Notes / Conditions
Power Up Time				1	ms	
Soft Reset Time				15	ms	
Duration of Reset Pulse			3		ms	Refer to Pin4 on Table 6 Pin Assignment
			7.8		ms	Humidity OSR = 3 (0.007%RH)
Humidity Conversion Time	T <sub>conv</sub> hum		3.9		ms	Humidity OSR = 2 (0.010%RH)
•			2.0		ms	Humidity OSR = 1 (0.014%RH)
			1.0		ms	Humidity OSR = 0 (0.020%RH)
			12.1		ms	Temperature OSR = 3 (0.012°C)
Temperature Conversion Time	T <sub>conv temp</sub>		6.1		ms	Temperature OSR = 2 (0.016°C)
			3.1		ms	Temperature OSR = 1 (0.025°C)
			1.6		ms	Temperature OSR = 0 (0.040°C)

Table 5 Timing Specifications

<sup>&</sup>lt;sup>9</sup> One RH and temperature measurement per second, OSR0

# INTERFACES

## Pin Assignment

N°	Function	Description	TOP VIEW		BOTTOM VIEW	
1	SDA	Serial Data Output / Input				
2	GND	Ground	PIN 4	PIN 3	PIN 3	PIN 4
3	IC_Add	Address Selection	PIN 5	PIN 2	PIN 2	PIN 5
4	RST	Reset		L		
5	VDD	Supply Voltage	PIN 6	PIN 1	PIN 1	PIN 6
6	SCL	Clock				

Table 6 Pin Assignment

#### I<sup>2</sup>C Communication Pins (SDA / SCL)

SCL is used to synchronize the communication between microcontroller and HTU31D sensor. Since the interface consists of fully static logic there is no minimum SCL frequency. The SDA pin is used to transfer data in and out of the device. To send a command to HTU31D sensor, SDA is valid on the rising edge of SCL and shall remain stable while SCL is high. Following the falling edge of SCL, SDA value may be changed. To guaranty safe communication SDA shall be valid tQS and tQH before the rising and after the falling edge of SCL, respectively. To read data from HTU31D sensor, SDA is valid tVD after SCL has gone low and remains valid until the next SCL falling edge.

An external pull-up resistor (e.g.  $10k\Omega^{10}$ ) on SCL and SDA is required to pull the signal high only for open collector or open drain technology microcontrollers. In most case, pull-up resistors are internally included in I/O microcontroller circuits.

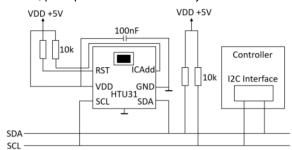


Figure 4 I2C Typical Application Circuit

#### Power Pins (VDD / GND)

Typical circuit includes a 100nF decoupling capacitor between VDD and GND, located as close as possible to the sensor. GND pin is internally connected to central pad. Depending on application electronic board thermal characteristics, soldering of this central pad may be recommended or not (cf. Thermal Resistance Information Page 15).

#### IC\_Add Pin

The IC\_Add pin allows the user to dynamically change sensor I2C address to connect multiple sensors on the same I2C network. The level applied to the IC\_Add pin shall remain constant from the start to the end of the 2C communication (see Communication and Operation section). If IC\_Add pin is not used, it is recommended to connect it to GND (I2C address 0x40) or VDD with a  $10k\Omega$  series resistance (I2C address 0x41) as represented in Figure 4 I2C Typical Application Circuit.

#### RST Pin

The RST pin can be used to generate a reset of the sensor. A minimum pulse of 1  $\mu$ s is required to reliably trigger a sensor reset. If RST pin is not used, it is recommended to connect it to VDD with a  $10k\Omega$  series resistance.

<sup>10</sup> Pull-up resistor value is valid if the HTU is alone on I2C bus functioning at 100kHz, otherwise please refer to UM10204, Rev. 6, April 4, 2014

# COMMUNICATION AND OPERATION

#### I<sup>2</sup>C Address

HTU31 series has the capability to respond 2 distinct I<sup>2</sup>C addresses. This feature allows to use multiple sensors on the same I<sup>2</sup>C network and avoid address conflict with other components.

#### Hardwired Dynamic Address

The hardwired address is defined by the IC\_ADD pin level (it sets the LSB value). It can be used to connect 2 sensors on the same I<sup>2</sup>C network (one wired to VDD, the other to GND). To connect more than 2 sensors on the same I<sup>2</sup>C network, individual IC\_ADD lines can be used.

IC_ADD Pin level	Sensor I2C address (Hex)
GND	0x40
VDD	0x41

Table 7 Sensor I<sup>2</sup>C Address

#### Software Address

By default, the software address is not activated however it can be set to any I2C valid address by TE Connectivity upon request.

# Input / Output Characteristics

Characteristics	Symbol	Min	Max	Unit
Output Low Voltage	VOL	0.0 V <sub>DD</sub>	0.2 V <sub>DD</sub>	V
Output High Voltage	VOH	$0.8V_{DD}$	$V_{DD}$	V
Input Low Voltage	VIL	0.0 V <sub>DD</sub>	0.3 V <sub>DD</sub>	V
Input High Voltage	VIH	0.7 V <sub>DD</sub>	$V_{DD}$	V

Table 8 Input and Output Characteristics

## Timing Specifications of Digital input/output pads for I<sup>2</sup>C Fast Mode

Characteristics	Symbol	Min	Тур	Max	Unit	Notes / Conditions
SCL frequency	fscl		400	1000	kHz	Refer to UM10204
SCL high time	thigh	40			ns	
SCL low time	tlow	60			ns	
SCL setup to falling SDA	tsu:sta	20			ns	repeated start
SCL hold to falling SDA	thd:sta	20			ns	signaling start
SDA setup to SCL rising	tsu:dat	20			ns	
SDA hold to SCL falling	thd:dat	20			ns	SDA input
SDA delay to SCL falling	tsu:dout		5	20	ns	SDA output, internal chip delay without loading

Table 9 Timing Specifications for I<sup>2</sup>C Fast Mode

#### Sensor Functions

#### General

Every I<sup>2</sup>C message starts with the start condition and it is ended with the stop condition. Every command consists of two bytes: the address byte and the command byte. The sensor address is 1000'00x. The x in the address is defined with the value at the input of the I2C\_LSB pin. If I2C\_LSB =0 then the address will be 1000'000 (0x40), while if the I2C\_LSB = 1 then the address will be 1000'001 (0x41). This feature allows two sensors to operate on the same I2C bus.

<b>Command Byte</b>	7	6	5	4	3	2	1	0
Command Name	CMD	CMD	CMD	CMD	CMD	CMD	CMD	Stop
Conversion	0	1	0	OSRRH1	OSRRH0	OSRT1	OSRT0	Χ
Read T & RH	0	0	0	0	0	0	0	Χ
Read RH	0	0	0	1	0	0	0	Χ
Reset	0	0	0	1	1	1	1	Х
Heater on	0	0	0	0	0	1	0	Х
Heater off	0	0	0	0	0	0	1	Х
Read serial number	0	0	0	0	1	0	1	Х
Read Diagnostic	0	0	0	0	1	0	0	X

Table 10 User Commands

#### Temperature & Humidity Measurement Sequence

- 1) Execute "Conversion" command with the desired resolution to perform measurement and load it in sensor memory
- 2) Wait for the conversion time (see *Table 5 Timing Specifications*)
- 3) Execute "Read T & RH" or "Read RH" command to read measurement Note: Humidity and temperature values will be updated by the "Conversion" command.

#### Conversion

The conversion command triggers a single temperature and humidity conversion with Selected Resolution OSR:

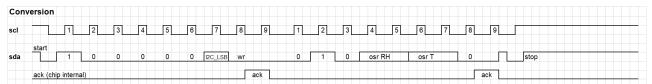


Figure 5 Conversion Command

Abbreviation	Binary value	Description
osrRH1osrRH0	11	Humidity OSR = 3 (0.007%RH)
	10	Humidity OSR = 2 (0.010%RH)
	01	Humidity OSR = 1 (0.014%RH)
	00	Humidity OSR = 0 (0.020%RH)
osrT1osrT0	11	Temperature OSR = 3 (0.012°C)
	10	Temperature OSR = 2 (0.016°C)
	01	Temperature OSR = 1 (0.025°C)
	00	Temperature OSR = 0 (0.040°C)

Table 11 Humidity and Temperature Conversion Parameters and Associated Resolution

#### Read T & RH

The Read T & RH command can be used either to read only the temperature or both the temperature and the humidity. The 16 temperature data bits are followed by an 8-bit temperature CRC. The 16 RH data bits are followed by an 8-bit RH CRC. The data reading can be stopped any time by sending a not acknowledge (nack) and stop sequence. This can be used, for example, when only the temperature data is needed.

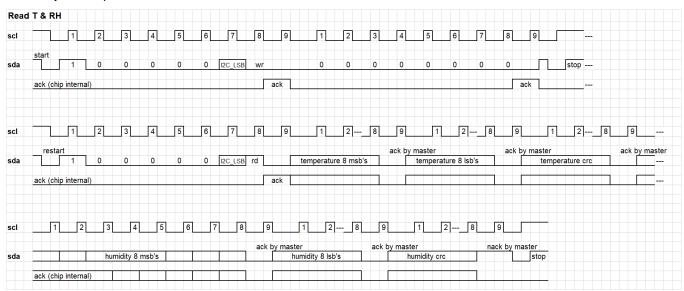


Figure 6 Read T&RH command

Note: The not acknowledge (nack) and stop at the end of the reading is mandatory, otherwise the chip may block the SDA.

#### Read RH

The Read RH command is available when only the relative humidity (RH) data is needed. The 16 RH data bits are followed by an 8-bit CRC. When the CRC is not required, the data reading can be stopped after the 16 RH data bits by sending a not acknowledge (nack) and stop sequence.

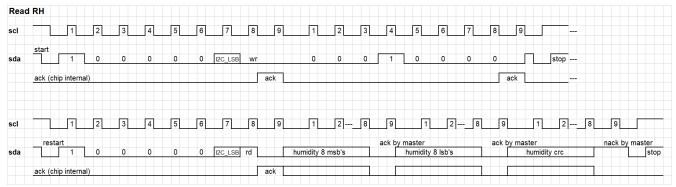


Figure 7 Read RH Command

Note: The not acknowledge (nack) and stop at the end of the reading is mandatory, otherwise the chip may block the SDA.

#### Reset

Reset command is used to reboot the HTU31D switching the power off and on again. Upon reception of this command, the HTU31D reinitializes and starts operation according to the default settings. The reset takes less than 5ms.

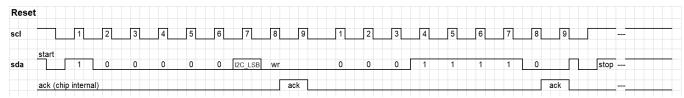


Figure 8 Soft Reset Command

#### Heater on

The sensor includes a built-in heater which can be switched on by the following command:

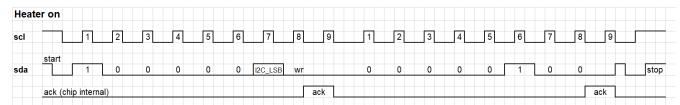


Figure 9 Heater on Command

#### Heater off

To switch the heater off, a reset command or the following command must be applied:

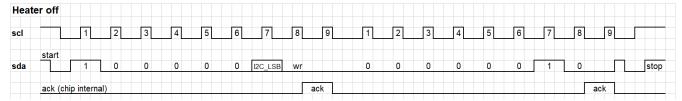


Figure 10 Heater off Command

#### Read serial number

For identification of the chip, the serial number can be read. The 24-bit serial number data is followed by an 8-bit CRC:

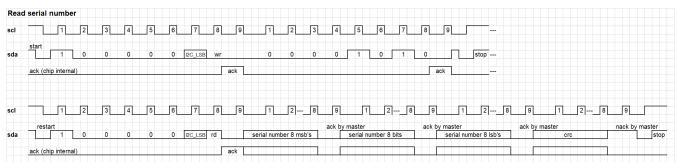


Figure 11 Read serial number Command

Note: The not acknowledge (nack) and stop at the end of the reading is mandatory, otherwise the chip may block the SDA.

# Read Diagnostic

A diagnostic register is available to check if the humidity and temperature are working properly, if the humidity or temperature are out of specified range, the heater and the memory status:

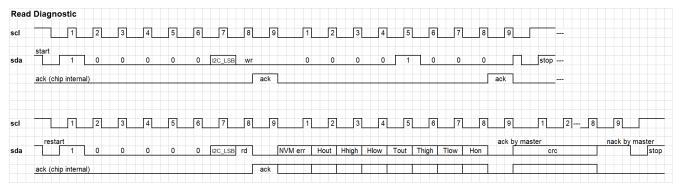


Figure 12 Read Serial number command

Note: The not acknowledge (nack) and stop at the end of the reading is mandatory, otherwise the chip may block the SDA.

#### **Diagnostic Register**

7	6	5	4	3	2	1	0
NVM error (NVM err)	Humidity under/overrun (Hout)	Humidity high error (Hhigh)	Humidity low error (Hlow)	Temperature under/overrun (Tout)	Temperature high error (Thigh)	Temperature low error (Tlow)	Heater on (Hon)

Table 12 Diagnostic Register

Abbreviation	Description
NVM error (NVM err)	bit is set if the CRC of the NVM has failed (CRC is done on the register copy)
Humidity under/overrun (Hout)	bit is set if the humidity is truncated to 0 or the max value of 2^16-1
Humidity high error (Hhigh)	bit is set if the humidity calculation results above 120 %RH
Humidity low error (Hlow)	bit is set if the humidity calculation results below -10 %RH
Temperature under/overrun (Tout)	bit is set if the temperature is truncated to 0 or the max value of 2^16-1
Temperature high error (Thigh)	bit is set if the temperature calculation results above 150 °C
Temperature low error (Tlow)	bit is set if the temperature calculation results below -50 °C
Heater on (Hon)	bit is set if the heater is on

Table 13 Diagnostic Register Bits Description

#### CRC

#### **CRC Checksum**

HTU31D sensor includes a CRC-8 checksum for error detection. The polynomial used is  $X^8 + X^5 + X^4 + 1$ .

#### **Basic Considerations**

CRC stands for Cyclic Redundancy Check. It is one of the most effective error detection schemes and requires a minimal amount of resources.

The types of detectable errors with CRC implemented in HTU31D sensors are:

- Any odd number of errors anywhere in the data transmission
- All double-bit errors anywhere in the data transmission
- Any cluster of errors that can be contained within an 8-bit window (1-8 bits incorrect)
- Most larger clusters of errors

A CRC is an error-detecting code commonly used in digital networks and storage devices to detect accidental changes to raw data.

Blocks of data entering these systems get a short check value attached, based on the remainder of a polynomial division of their contents; on retrieval the calculation is repeated, and corrective action can be taken against presumed data corruption if the check values do not match.

CRCs are so called because the check (data verification) value is a redundancy (it expands the message without adding information) and the algorithm is based on cyclic codes. CRCs are popular because they are simple to implement in binary hardware, easy to analyze mathematically, and particularly effective to detect common errors caused by noise in transmission channels. As the check value has a fixed length, the function that generates it is occasionally used as a hash function.

When HTU31D operates with standard I<sup>2</sup>C protocol, an 8-bit CRC can be used to detect transmission errors. The CRC covers all read data transmitted by the sensor. CRC properties for HTU31D communicating with I<sup>2</sup>C protocol are listed below:

CRC with I <sup>2</sup> C protocol				
Generator polynomial	$X^8 + X^5 + X^4 + 1$			
Initialization	0x00			
Protected data	Read data			
Final Operation	none			

Table 14 I<sup>2</sup>C CRC Properties

#### **CRC Calculation**

To compute a n-bit binary CRC, line bits representing the input in a row, and position the (n+1)-bit pattern representing the CRC's divisor (called a "polynomial") underneath the left-hand end of the row. This is first padded with zeroes corresponding to the bit length n of the CRC. If the input bit above the leftmost divisor bit is 0, do nothing. If the input bit above the left most divisor bit is 1, the divisor is XORed into the input (in other words, the input bit above each 1-bit in the divisor is toggled). The divisor is then shifted one bit to the right, and the process is repeated until the divisor reaches the right-hand end of the input row. Since the left most divisor bit zeroed every input bit it touched, when this process ends the only bits in the input row that can be non-zero are the n bits at the right-hand end of the row. These n bits are the remainder of the division step and will also be the value of the CRC function. The validity of a received message can easily be verified by performing the above calculation again, this time with the check value added instead of zeroes. The remainder should equal zero if there are no detectable errors.

#### **CRC Examples**

The input message 11011100 (0xDC) will have as result 01111001 (0x79).

The input message 01101000 00111010 (0x683A) will have as result 011111100 (0x7C).

The input message 01001110 10000101 (0x4E85) will have as result 01101011 (0x6B).

## Conversion of Signal Outputs

Measurement data are transferred as 16-bit values (unsigned integer).

Converting those raw values into a physical measurement can be achieved using the following formulas:

#### Relative Humidity Conversion

From the relative humidity output SRH (decimal), the relative humidity RH (%RH) is obtained by the following formula, this formula being applicable whatever selected resolution (OSR):

$$RH = 100 \times \frac{S_{RH}}{2^{16} - 1}$$

#### **Temperature Conversion**

From the temperature output  $S_T$  (decimal), the temperature T (°C) is obtained by the following formula, this formula being applicable whatever selected resolution (OSR):

$$T = -40 + 165 \times \frac{S_T}{2^{16} - 1}$$

Note: these formulas are only valid with decimal representation of ST and SRH

## **Dew Point Temperature Calculation**

The dew point is the temperature at which the water vapor in the air becomes saturated and condensation begins.

The dew point is associated with relative humidity. A high relative humidity indicates that the dew point is closer to the current air temperature. Relative humidity of 100% indicates that the dew point is equal to the current temperature (and the air is maximally saturated with water). When the dew point stays constant and temperature increases, relative humidity will decrease.

#### Partial Pressure (PPTamb) Calculation from Ambient Temperature

Partial Pressure (PPTamb) is calculated using temperature measurement from HTU31 sensor with the following formula:

$$PP_{Tamb} = 10^{\begin{bmatrix} A - \frac{B}{(Tamb + C)} \end{bmatrix}}$$
 $PP_{Tamb}$ 
Partial Pressure in mmHg at Ambient Temperature

Tamb
Ambient Temperature in °C, from HTU31

A, B, C Constants: A=8.1332; B=1762.39; C=235.66

#### Dew Point Temperature (T<sub>d</sub>) Calculation from Partial Pressure (PP<sub>Tamb</sub>)

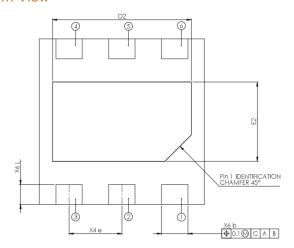
Dew point temperature (T<sub>d</sub>) of the air is calculated using ambient relative humidity and temperature measurements from HTU31 sensor with the following formula:

$$T_{d} = - \begin{bmatrix} B \\ \hline \log_{10} \left(RH_{amb} \times \frac{PP_{Tamb}}{100}\right) - A \end{bmatrix} \\ = - \begin{bmatrix} RH_{amb} \\ \hline \log_{10} \left(RH_{amb} \times \frac{PP_{Tamb}}{100}\right) - A \end{bmatrix} \\ = - \begin{bmatrix} RH_{amb} \\ \hline RH_{amb$$

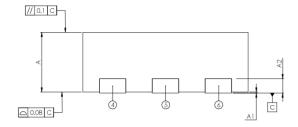
# **PACKAGING AND ASSEMBLY INFORMATION**

# Package Outline

## **Bottom View**

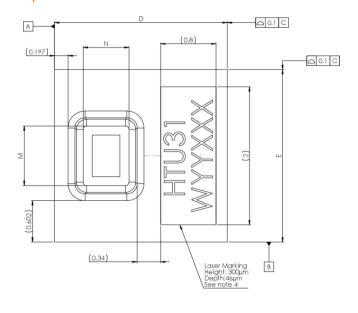


## Side View



Description	"W" in the marking
HTU31 Digital	D
HTU31 Analog	V

# Top View



BOL	COMMON							
SYMBOL	DIMENS	IONS MIL	LIMETER	DIMENSIONS INCH				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	0.85	0.90	0.95	0.033	0.035	0.037		
Al	0.00	0.02	0.05	0.000	0.001	0.002		
A2	0.203 REF			0.008 REF				
b	0.35	0.40	0.45	0.014	0.016	0.018		
D	2.45	2.50	2.55	0.096	0.098	0.100		
D2	2.05	2.10	2.15	0.081	0.083	0.085		
Е	2.45	2.50	2.55	0.096	0.098	0.100		
E2	1.15	1.20	1.25	0.045	0.047	0.049		
е	0.80 BSC			0.031 BSC				
L	0.25 0.30 (		0.35	0.010	0.010 0.012			
М		0.860 REF	=	0.034 REF				
Ν		0.660 REF	:	0.026 REF				

## Packaging Type

HTU31 is provided in DFN type package (Dual Flat No leads). HTU31 sensor chip is mounted on a Cu and plated with Ni/Pd/Au lead frame.

## Traceability Information

## **Sensor Marking**

Each HTU31D sensor is laser marked with an alphanumeric code (cf. Top view Page14). The marking, engraved on two lines, contains following information:

- The first line denotes the sensor type: HTU31.
- The second line noted WYYXXX denotes Output mode and Date Code:
  - o W refers to Output mode: D = Digital (I2C) Output; V = Voltage Analog Output
  - o YY digits defines the manufacturing year: 21=2021, 22=2022.
  - XXX refers to the day number.

#### Reel Package Marking

Reels are also labeled for lot identification and additional traceability information, as shown below:



The reel label includes:

- Part Number
- Individual Lot Number (3X stands for HTU31, D for Digital Output, Individual Lot Number)
- Quantity
- Date Code

#### Thermal Resistance Information

Characteristics	Symbol	Value	Unit
Junction-to-Ambient Thermal Resistance	$ heta_{JA}$	55	°C/W
Junction-to-Board Thermal Resistance	$ heta_{JB}$	16	°C/W
Junction-to-Case Thermal Resistance	$ heta_{JC}$	3	°C/W
Junction-to-Top Characterization Parameter	$\psi_{JT}$	2	°C/W

Table 15 Thermal Resistance Values

Values are based on simulations and are offered for general reference use.

Depending on application electronic board thermal characteristics, soldering of central pad may be recommended or not. In case of application electronic board (excluding HTU31) low self-heating, soldering of central pad is recommended. In case of application electronic board (excluding HTU31) high self-heating, soldering of central pad may not be recommended.

## Tape & Reel Packaging

HTU31D sensors are delivered in tape & reel packaging, sealed into antistatic ESD bags.

Standard packaging sizes are 400, 1500 and 5000 units per reel.

Each reel contains 440mm (55 pockets) header tape and 200mm (25 pockets) trailer tape.

For 400 and 1500 units: outside diameter of 7" (178mm) and a 1/2" (13mm) diameter arbor hole.

For 5000 units: outside diameter of 13" (330mm) and a 1/2" (13mm) diameter arbor hole.

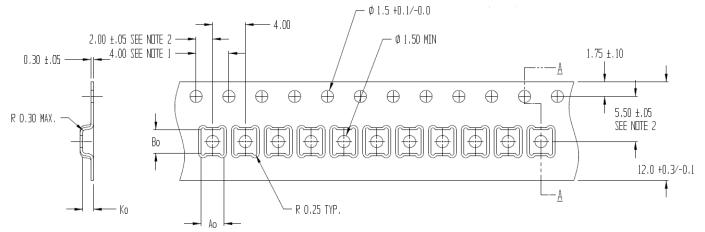


Figure 13 Tape and Reel Drawing

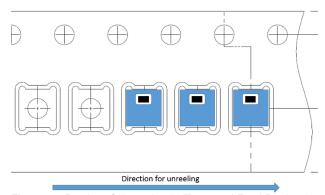


Figure 14 Product Orientation in Tape and Reel Packaging

## Recommended Footprint for PCBa Assembly

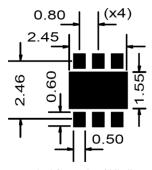


Figure 15 Recommended footprint (All dimensions are in mm)

## Handling & Storage Recommendations

To guaranty and preserve the high-quality performance of the HTU31 sensor, the following recommendations shall be respected concerning storage and packaging:

Prior sensors use or assembly, it is recommended to store them in their original sealed anti ESD packaging. If sensors have been removed from their original packaging, it is recommended to keep them in anti-static shielded ESD bags.

HTU31 sensor shall not be in contact with volatile chemicals such as solvents or other organic compounds that could induce a sensing element pollution or damage.

HTU31 sensor is classified MSL level 1 according to IPC/JEDEC J-STD-020.1 for storage, packaging and handling.

The typical shelf life is 1 year at temperature below 30°C and relative humidity below 85%RH.

HTU31 sensor shall be protected from ESD (Electrostatic Discharge) and shall be handled in ESD protected areas (EPA) under protected and standard controlled conditions (ground with wrist-straps, ground all non-insulating and conductive objects, operate only in grounded conductive floor.



Figure 16 Protection against ESD mandatory

## Soldering and Assembly Instructions

HTU31 sensor is designed to withstand soldering profile according to IPC/JEDEC J-STD-020 with peak temperatures at 260°C during up to 30sec for Pb-free assembly in reflow ovens.

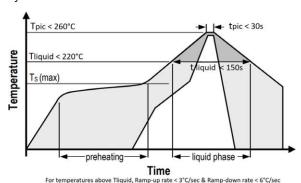


Figure 17 Reflow Soldering profile according to JEDEC standard

Standard pick & place equipment and vacuum nozzles for standard DFN packages may be used for assembly of HTU31 sensors.

For manual soldering contact time must be limited to 5 seconds at 350°C.

The use of "no clean" solder paste is recommended to avoid pollution or damage of RH sensing element.

In case of applications with exposure of the sensor to corrosive gases or condensed water (i.e. environments with high relative humidity) the soldering pads shall be sealed (e.g. conformal coating) to prevent loose contacts or short cuts.

No board wash shall be applied to HTU31 sensors without appropriate sensor upper surface adhesive tape protection.

No coating shall be applied to HTU31 sensors without appropriate sensor upper surface adhesive tape protection.

Immediately after soldering high thermal stress, HTU31 sensors may temporarily read a normal slight RH negative deviation (<1%RH) corresponding to sensing element extreme drying. This slight normal deviation will disappear after one or two days.

# ORDERING INFORMATION

# Output Signal Part Number D | I^2C Digital HTU31x V | Ratiometric Voltage

Description	Quantity	Part number
HTU31D RH/T IC DIGITAL R400	400	10142048-20
HTU31D RH/T IC DIGITAL R1500	1500	10142048-21
HTU31D RH/T IC DIGITAL R5000	5000	10142048-22
HTU31V RH/T IC ANALOG R400	400	10142048-30
HTU31V RH/T IC ANALOG R1500	1500	10142048-31
HTU31V RH/T IC ANALOG R5000	5000	10142048-32
Demonstration Board HTU31D	1	10142605-10
Demonstration Board HTU31V	1	10142605-02

#### **REVISION HISTORY**

DATE	VERSION	PAGE(S)	CHANGES
January 2021	3	2/4/6/7/13	Update of Humidity Response Time, Long-Term Drift, ESD 4kV, Interfaces, Voltage Outputs, Part numbers
May 2022	4	2/4/6/15/18	Update of Humidity Response Time, Long-Term Drift, ESD 8kV, High T Storage, Bottom Pad, Thermal Resistance, Part numbers

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Version #4 05/2022



te.com







#### **Features**

- . High Reliability and Robustness
- Fast Recovery after Saturation
- Fully Compatible with Reflow Process
- Fully Interchangeable without Calibration
- Serial Individual Marking for Traceability
- Lead Free
- Low Power Consumption

#### **Applications**

- Home Appliance
- HVAC
- Medical Respirators CPAP and Ventilators
- Industrial Transport / Cold Chain
- Humidifiers / Dehumidifier
- Meteorology
- Environmental Monitoring & Trackers
- IoT Applications
- IP Camera
- Water Leak Detector

CLICK HERE > CONNECT WITH A SPECIALIST

# HTU31V RH/T SENSOR IC

Analog Relative Humidity & Temperature Sensor

#### Characteristics

- Fully calibrated, temperature compensated
- High accuracy: ±2%RH and ±0.2°C
- Fast humidity response time: 3s
- Long term drift: <0.1%RH/year
- Wide supply voltage range from 3V to 5.5V
- Low average current: 161µA typical
- Compact 6-Pin DFN package: 2.5x2.5x0.9mm
- Ratiometric voltage output
- Fully RoHS and REACH compliant

# **General Description**

The HTU31 is one of the smallest and most accurate humidity sensors on the market. TE Connectivity precision engineering and 20+ years of experience in humidity and temperature combination sensors, enabled this new product with fast response time, precision measurement, low hysteresis, robustness to reflow assembly process and sustained performance even when exposed to extreme temperature [-40° to 125°C] and humidity [0%RH to 100%RH] environments.

HTU31 humidity & temperature sensor includes both digital (D) and analog (V) versions and combines multiple functions with an application-friendly operating supply voltage range from 3V to 5.5V.

HTU31 sensor is available in small and large volumes to meet the ever-changing demands of our customers.

# PERFORMANCE SPECIFICATIONS

## Relative Humidity Specifications

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Condition	Value	Units	Notes / Conditions
Humidity Operating Range	Max <sup>1</sup>	0 to 100	%RH	
Relative Humidity Accuracy	Typical	±2	%RH	Figure 1 Humidity Sensor Rating @25°C
Resolution	Typical	0.01	%RH	
Hysteresis	@25°C	±0.7	%RH	
Response Time <sup>2</sup>	τ63%	3	S	
Recovery Time after Condensation <sup>3</sup>	τ100%	10	S	
Long Term Drift <sup>4</sup>	Typical	<0.1	%RH / year	

Table 1 Humidity Specifications

# **Temperature Specifications**

 $V_{dd} = 5V \ 25^{\circ}C$ 

Characteristics	Condition	Value	Units	Notes / Conditions
Temperature Operating Range		-40 to 125	°C	
Temperature Accuracy	Typical	±0.2	°C	Figure 2 Temperature Sensor Rating
Resolution	Typical	0.016	°C	
Response Time <sup>2</sup>	τ63%	10	S	
Long Term Drift	Typical	0.04	°C / year	

Table 2 Temperature Specifications

<sup>&</sup>lt;sup>1</sup> Cf. Figure 3 Humidity and Temperature Operating Range

<sup>&</sup>lt;sup>2</sup> With 1m.s<sup>-1</sup> air flow

<sup>&</sup>lt;sup>3</sup> Measured according to AFNOR standard NFX 15-113, with 3 m.s<sup>-1</sup> air flow

<sup>&</sup>lt;sup>4</sup> Typical application in regular environmental variation within optimum measurement range

# **Humidity Sensor Rating**

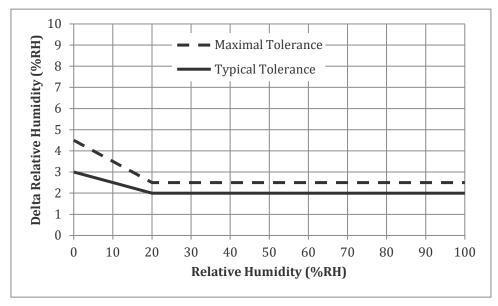


Figure 1 Humidity Sensor Rating @25°C

# **Temperature Sensor Rating**

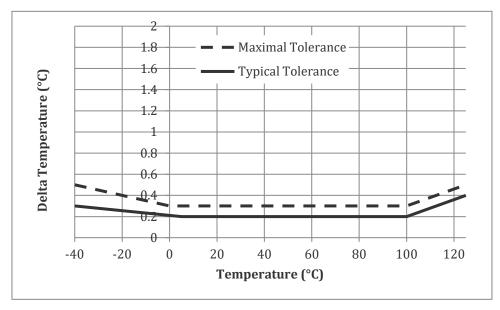


Figure 2 Temperature Sensor Rating

# **SENSOR INTEGRATION**

**Absolute Maximum Operating Conditions** 

Ratings	Symbol	Value Unit		Notes / Conditions
Storage Temperature <sup>5</sup>	Tstg	-40 to 200	°C	
Supply Voltage (Peak)	Vcc	5.5	Vdc	
Humidity Operating Range	RH	0 to 100	%RH	
Temperature Operating Range	Та	-40 to +125	°C	
VDD to GND		-0.3 to 5.5	V	
ESD HBM (Human Body Model) <sup>6</sup>		±8	kV	
ESD CDM (Charged Device Model) <sup>7</sup>		750	V	
Latch Up Sensitivity <sup>8</sup>		±300	mA	

Table 3 Maximum Operating Conditions

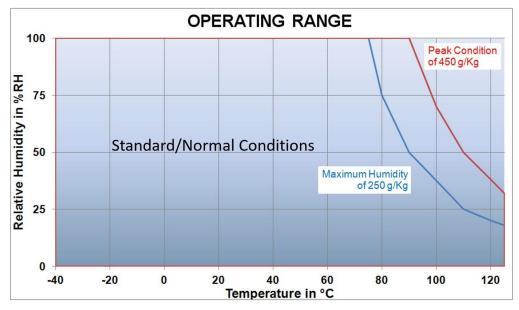


Figure 3 Humidity and Temperature Operating Range

The sensor should operate at peak condition less than 10% of the operating life. Exposure to absolute maximum humidity/temperature conditions for extended periods may temporarily induce an offset on RH measurement (+5%RH above accuracy specifications, which will recover over time) and accelerate its ageing.

<sup>&</sup>lt;sup>5</sup> Sensor in specifications after 1000h storage @125°C; No failure after 1000h storage @200°C

<sup>&</sup>lt;sup>6</sup> According to ANSI/ESDA/JEDEC JS-001-2017, AEC-Q100-002.

<sup>&</sup>lt;sup>7</sup> According to JESD22-C101, AEC-Q100-011

<sup>&</sup>lt;sup>8</sup> According to JESD78

# **Electrical Specifications**

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Symbol	Min	Тур	Max	Unit	Notes / Conditions
Supply Voltage	$V_{dd}$	3.0	5.0	5.5	V	
Current Consumption	i <sub>dd</sub>		161		μΑ	Typical
			511		μΑ	Peak
Power Dissipation			805		μW	Typical
. Ono. Dioo.pation			2.55		mW	Peak
Buffer Output Current				±200	μΑ	
Buffer Capacitive Load		0.0		5.0	nF	

Table 4 Electrical Specifications

# **Timing Specifications**

 $V_{dd} = 5V 25^{\circ}C$ 

Characteristics	Symbol	Min	Тур	Max	Unit	Notes / Conditions
Power Up Time				10	ms	

Table 5 Timing Specifications

# **INTERFACES**

## Pin Assignment

N°	Function	Description	TOP VIEW		BOTTOM VIEW	
1	RH	RH Ratiometric Voltage Output		·		
2	GND	Ground	PIN 4	PIN 3	PIN 3 — PIN	14
3	BUF	Buffer Off Control	PIN 5	PIN 2	PIN 2 PIN	N 5
4	RST	Reset		i		
5	VDD	Supply Voltage	PIN 6	PIN 1	PIN 1 PIN	16
6	TEMP	Temp. Ratiometric Voltage Output				

Table 6 Pin Assignment

Relative Humidity and Temperature Ratiometric Voltage Output Pins (RH / TEMP)

Relative humidity voltage output is directly provided via RH pin. Temperature voltage output is directly provided via TEMP pin.

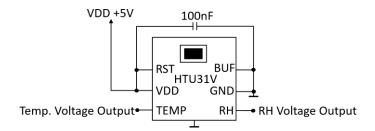


Figure 4 HTU31V Typical Application Circuit

# Power Pins (VDD / GND)

Typical circuit includes a 100nF decoupling capacitor between VDD and GND, located as close as possible to the sensor. GND pin is internally connected to central pad. Depending on application electronic board thermal characteristics, soldering of this central pad may be recommended or not (cf. Thermal Resistance Information Page 10).

#### **BUF Pin**

The HTU31V includes a built-in output buffer for the two voltage RH and temperature outputs.

The BUF pin is used to enable or disable this output buffer.

- When BUF pin is connected to GND, as represented in *Figure 4 HTU31V Typical Application Circuit*, voltage output buffer is on, this is the recommended configuration for most applications.
- When BUF pin is connected to VDD, analog output buffer is off, the voltage outputs will be at high impedance, an
  external buffer is then highly recommended. Loading on RH and TEMP pins must be higher than 1GΩ to avoid nonlinear
  effects.

#### **RST Pin**

The RST pin can be used to generate a reset of the sensor. A minimum pulse of 1µs is required to reliably trigger a sensor reset.

- When RST pin is connected to GND, chip in reset / power down mode.
- When RST pin is connected to VDD, chip is in operating mode.

If reset feature is not used, RST pin must be connected to VDD, as represented in Figure 4 HTU31V Typical Application Circuit.

# COMMUNICATION AND OPERATION

Conversion of Ratiometric Voltage Outputs

## **Relative Humidity Conversion**

From the voltage output  $V_{RH}$ , updated each 250ms, the relative humidity in %RH is obtained by the following formula:

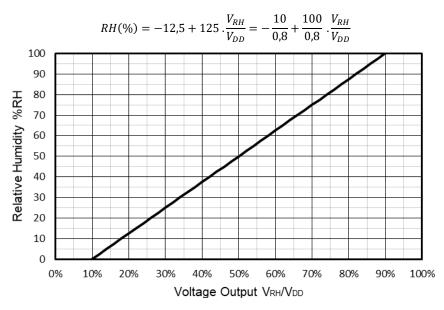


Figure 5 Relationship between ratiometric voltage output and measured relative humidity in %RH

#### **Temperature Conversion**

From the voltage output 
$$V_T$$
, updated each 250ms, the temperature T in °C or in °F is obtained by the following formulas: 
$$T(°C) = -60,625 + 206,25 \cdot \frac{V_T}{V_{DD}} = -40 - \frac{16,5}{0,8} + \frac{165}{0,8} \cdot \frac{V_T}{V_{DD}}$$

$$T(^{\circ}F) = -77,125 + 371,25 \cdot \frac{V_T}{V_{DD}} = -40 - \frac{29,7}{0,8} + \frac{297}{0,8} \cdot \frac{V_T}{V_{DD}}$$

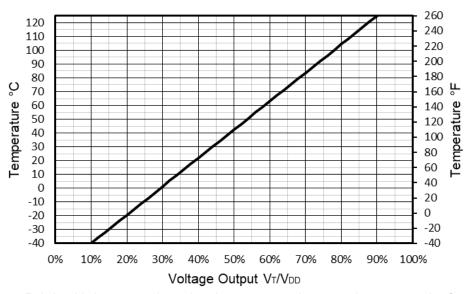


Figure 6 Relationship between ratiometric voltage output and measured temperature in °C and °F

#### **Error Codes**

## Relative Humidity

In case of abnormal open circuit, the voltage output  $V_{RH}$  will provide an error code :  $V_{RH}$ =0V. In case of abnormal short circuit, the voltage output  $V_{RH}$  will provide an error code :  $V_{RH}$ = $V_{DD}$ .

#### **Temperature**

In case of abnormal open circuit or values below -50°C, the voltage output  $V_T$  will provide an error code :  $V_T$ =0V. In case of values between -50°C and -40°C, the voltage output  $V_T$  will provide a clamping :  $V_T = \frac{V_T}{V_{DD}} = 10\%$ . In case of values between 125°C and 150°C, the voltage output  $V_T$  will provide a clamping :  $V_T = \frac{V_T}{V_{DD}} = 90\%$ . In case of abnormal short circuit or values above 150°C, the voltage output  $V_T$  will provide an error code :  $V_T = V_{DD}$ .

## **Dew Point Temperature Calculation**

The dew point is the temperature at which the water vapor in the air becomes saturated and condensation begins.

The dew point is associated with relative humidity. A high relative humidity indicates that the dew point is closer to the current air temperature. Relative humidity of 100% indicates that the dew point is equal to the current temperature (and the air is maximally saturated with water). When the dew point stays constant and temperature increases, relative humidity will decrease.

## Partial Pressure (PPTamb) Calculation from Ambient Temperature

Partial Pressure (PP<sub>Tamb</sub>) is calculated using temperature measurement from HTU31 sensor with the following formula:

$$PP_{Tamb} = 10^{\left[A - \frac{B}{(Tamb + C)}
ight]}$$
 PP<sub>Tamb</sub> Partial Pressure in mmHg at Ambient Temperature T<sub>amb</sub> Ambient Temperature in °C, from HTU31 A, B, C Constants: A=8.1332; B=1762.39; C=235.66

## Dew Point Temperature (Td) Calculation from Partial Pressure (PPTamb)

Dew point temperature (T<sub>d</sub>) of the air is calculated using ambient relative humidity and temperature measurements from HTU31 sensor with the following formula:

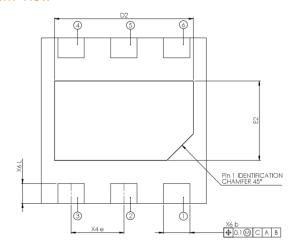
$$T_{d} = - \begin{bmatrix} B \\ \hline \log_{10} \left(RH_{amb} \times \frac{PP_{Tamb}}{100}\right) - A \end{bmatrix} \\ = - \begin{bmatrix} RH_{amb} & \text{Ambient Relative Humidity in \%RH, from HTU31} \\ T_{amb} & \text{Ambient Temperature in °C, from HTU31} \\ T_{d} & \text{Calculated Dew Point in °C} \\ A, B, C & \text{Constants: A=8.1332; B=1762.39; C=235.66} \end{bmatrix}$$

PP<sub>Tamb</sub> Partial Pressure in mmHg at Ambient Temperature

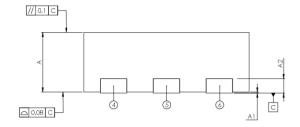
# **PACKAGING AND ASSEMBLY INFORMATION**

# Package Outline

## **Bottom View**

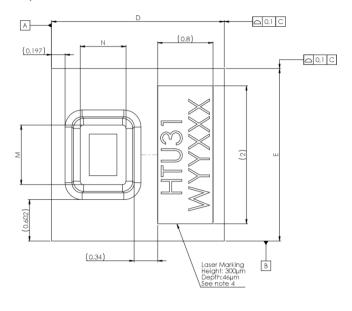


## Side View



Description	"W" in the marking
HTU31 Digital	D
HTU31 Analog	V

# Top View



BOL	COMMON					
SYMBOL	DIMENSIONS MILLIMETER		DIMENSIONS INCH			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.85	0.90	0.95	0.033	0.035	0.037
Al	0.00	0.02	0.05	0.000	0.001	0.002
A2	0.203 REF			0.008 REF		
b	0.35	0.40	0.45	0.014	0.016	0.018
D	2.45	2.50	2.55	0.096	0.098	0.100
D2	2.05	2.10	2.15	0.081	0.083	0.085
Е	2.45	2.50	2.55	0.096	0.098	0.100
E2	1.15	1.20	1.25	0.045	0.047	0.049
е	0.80 BSC			0.031 BSC		
L	0.25	0.30	0.35	0.010	0.012	0.014
М	0.860 REF			0.034 REF		
Ν	0.660 REF				0.026 REF	:

## Packaging Type

HTU31 is provided in DFN type package (Dual Flat No leads). HTU31 sensor chip is mounted on a Cu and plated with Ni/Pd/Au lead frame.

#### Traceability Information

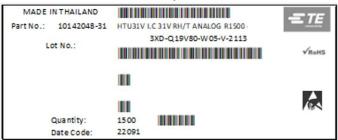
#### **Sensor Marking**

Each HTU31V sensor is laser marked with an alphanumeric code (cf. Top view Page 9). The marking, engraved on two lines, contains following information:

- The first line denotes the sensor type: HTU31.
- The second line noted WYYXXX denotes Output mode and Date Code:
  - o W refers to Output mode: D = Digital (I<sup>2</sup>C) Output; V = Voltage Analog Output
  - o YY digits defines the manufacturing year: 21=2021, 22=2022.
  - XXX refers to the day number.

#### Reel package Marking

Reels are also labeled for lot identification and additional traceability information, as shown below:



The reel label includes:

- Part Number
- Individual Lot Number (3X stands for HTU31, V for Voltage Output, Individual Lot Number)
- Quantity
- Date Code

#### Thermal Resistance Information

Characteristics	Symbol	Value	Unit
Junction-to-Ambient Thermal Resistance	$ heta_{JA}$	55	°C/W
Junction-to-Board Thermal Resistance	$ heta_{JB}$	16	°C/W
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Junction-to-Top Characterization Parameter	$\psi_{JT}$	2	°C/W

Table 7 Thermal Resistance Values

Values are based on simulations and are offered for general reference use.

Depending on application electronic board thermal characteristics, soldering of central pad may be recommended or not. In case of application electronic board (excluding HTU31) low self-heating, soldering of central pad is recommended. In case of application electronic board (excluding HTU31) high self-heating, soldering of central pad may not be recommended.

## Tape & Reel Packaging

HTU31V sensors are delivered in tape & reel packaging, sealed into antistatic ESD bags.

Standard packaging sizes are 400, 1500 and 5000 units per reel.

Each reel contains 440mm (55 pockets) header tape and 200mm (25 pockets) trailer tape.

For 400 and 1500 units: outside diameter of 7" (178mm) and a 1/2" (13mm) diameter arbor hole.

For 5000 units: outside diameter of 13" (330mm) and a 1/2" (13mm) diameter arbor hole.

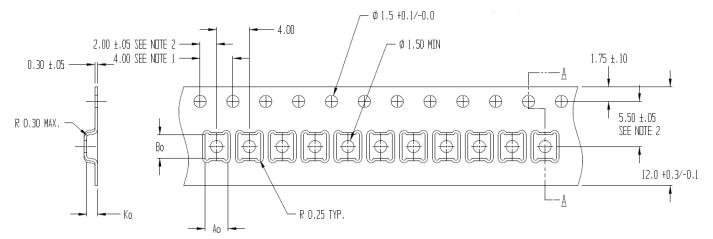


Figure 7 Tape and Reel Drawing

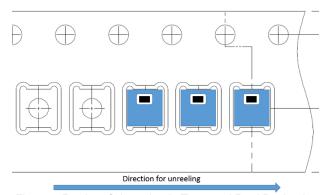


Figure 8 Product Orientation in Tape and Reel Packaging

## Recommended Footprint for PCBa Assembly

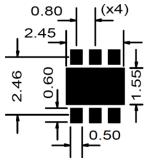


Figure 9 Recommended footprint (All dimensions are in mm)

## Handling & Storage Recommendations

To guaranty and preserve the high-quality performance of the HTU31 sensor, the following recommendations shall be respected concerning storage and packaging:

Prior sensors use or assembly, it is recommended to store them in their original sealed anti ESD packaging. If sensors have been removed from their original packaging, it is recommended to keep them in anti-static shielded ESD bags.

HTU31 sensor shall not be in contact with volatile chemicals such as solvents or other organic compounds that could induce a sensing element pollution or damage.

HTU31 sensor is classified MSL level 1 according to IPC/JEDEC J-STD-020.1 for storage, packaging and handling.

The typical shelf life is 1 year at temperature below 30°C and relative humidity below 85%RH.

HTU31 sensor shall be protected from ESD (Electrostatic Discharge) and shall be handled in ESD protected areas (EPA) under protected and standard controlled conditions (ground with wrist-straps, ground all non-insulating and conductive objects, operate only in grounded conductive floor.



Figure 10 Protection against ESD mandatory

## Soldering and Assembly Instructions

HTU31 sensor is designed to withstand soldering profile according to IPC/JEDEC J-STD-020 with peak temperatures at 260°C during up to 30sec for Pb-free assembly in reflow ovens.

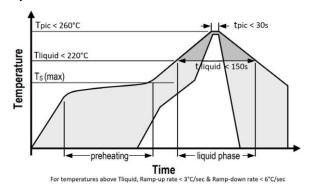


Figure 11 Reflow Soldering profile according to JEDEC standard

Standard pick & place equipment and vacuum nozzles for standard DFN packages may be used for assembly of HTU31 sensors.

For manual soldering contact time must be limited to 5 seconds at 350°C.

The use of "no clean" solder paste is recommended to avoid pollution or damage of RH sensing element.

In case of applications with exposure of the sensor to corrosive gases or condensed water (i.e. environments with high relative humidity) the soldering pads shall be sealed (e.g. conformal coating) to prevent loose contacts or short cuts.

No board wash shall be applied to HTU31 sensors without appropriate sensor upper surface adhesive tape protection.

No coating shall be applied to HTU31 sensors without appropriate sensor upper surface adhesive tape protection.

Immediately after soldering high thermal stress, HTU31 sensors may temporarily read a normal slight RH negative deviation (<1%RH) corresponding to sensing element extreme drying. This slight normal deviation will disappear after one or two days.

# ORDERING INFORMATION

# Output Signal Part Number D | I^2C Digital HTU31x V | Ratiometric Voltage

Description	Quantity	Part number
HTU31D RH/T IC DIGITAL R400	400	10142048-20
HTU31D RH/T IC DIGITAL R1500	1500	10142048-21
HTU31D RH/T IC DIGITAL R5000	5000	10142048-22
HTU31V RH/T IC ANALOG R400	400	10142048-30
HTU31V RH/T IC ANALOG R1500	1500	10142048-31
HTU31V RH/T IC ANALOG R5000	5000	10142048-32
Demonstration Board HTU31D	1	10142605-10
Demonstration Board HTU31V	1	10142605-02

#### **REVISION HISTORY**

DATE	VERSION	PAGE(S)	CHANGES
January 2021	3	2/4/6/7/13	Update of Humidity Response Time, Long-Term Drift, ESD 4kV, Interfaces, Voltage Outputs, Part numbers
May 2022	4	2/4/6/10/13	Update of Humidity Response Time, Long-Term Drift, ESD 8kV, High T Storage, Bottom Pad, Thermal Resistance, Part numbers

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